



Scanner Technologies Awarded New Patent for 3D BGA Inspection with a Single Camera

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MINNEAPOLIS--(BUSINESS WIRE)--March 2, 2005--Scanner Technologies (OTCBB:SCNI - News) today announced that it has been granted patent number 6,862,365 by the U.S. Patent & Trademark Office (USPTO) for the three dimensional inspection of Ball Grid Array (BGA) devices with a single camera.

Elwin Beaty, President and CEO of Scanner Technologies, stated, "We are pleased to add this patent to our strong portfolio of intellectual property for the inspection of electronic devices."

The patent claims a method of three dimensional inspection that obtains two views of a lead using illumination, fixed optics, a single camera, and a calibration to convert pixel positions into a world value.

About Scanner Technologies Corporation:

Scanner is a New Mexico corporation that invents, develops and markets vision inspection products that are used in the semiconductor industry for the inspection of integrated circuits. Scanner's headquarters are located in Minneapolis, Minnesota. The company has a manufacturing facility in Tempe, Arizona, and sells its products through direct sales offices in San Jose, California, Singapore and in key geographical markets, through sales representatives and distributors throughout the world. Scanner's stock is traded on the Over-The-Counter Bulletin Board under the symbol "SCNI." For more information please visit www.scannertech.com.

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